


PCB Layout

- Notes:
1. Insulator: PA4.6(UL94V-0)
 2. Contact: CuZn30
 3. Plating: 2u Ni+0,1-0,25u Au
 4. Insulation Resistance: $> 10^9 \Omega$
 5. Contact Resistance: $< 20m \Omega$
 6. Current Rating :2.5AM
 7. Operating Voltage : 250V AC
 8. Temperature : -55°C to +125°C
 9. Solder Temperature : 235°C(30-60 sec)
max. 260°C(10 sec)

RoHS compliant

Scale	1:1					Date	Name	Customer-No.
TOLERANCE						Drawn	13.12.2001	Hellwig
X.	$\pm X$					Approved	09.09.2009	Hellwig
X.X	$\pm X$							
X.XX	$\pm X$							
X°	$\pm X$	②	Update	09.09.2009	Dean			
		①	Drawn	13.12.2001	Hellwig			
		Id.	Modification	Date	Name	Replace	ASS 1223 CO	rev02
							Sheet	

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AP 119-xx/G-N

Drawing-No.
ASS 1223 CO rev02

Replace Sheet